

## TRIACS

- GLASS PASSIVATED CHIP
- $I_{GT}$  SPECIFIED IN FOUR QUADRANTS

### ADVANTAGES

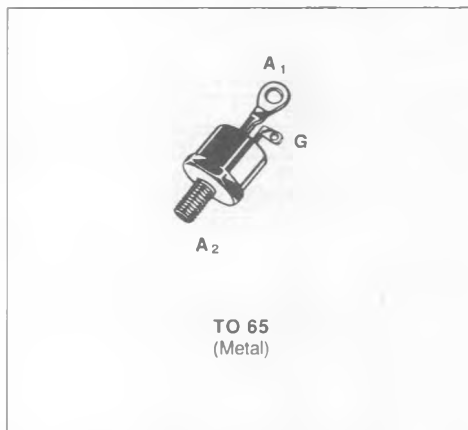
- EXCELLENT  $(dv/dt)_C : > 10 \text{ V}/\mu\text{s}$
- METALLIC ENCAPSULATION GIVES AN EXCELLENT THERMAL IMPEDANCE AND HIGH RELIABILITY CONSTRUCTION

### APPLICATIONS

- MOTOR CONTROL
- HEATING CONTROL
- LIGHT DIMMER

### DESCRIPTION

Power triacs suited for use on 220 V and 380 V main.



### ABSOLUTE RATINGS (limiting values)

| Symbol             | Parameter                                                                                         |                                   | Value                      | Unit                                 |
|--------------------|---------------------------------------------------------------------------------------------------|-----------------------------------|----------------------------|--------------------------------------|
| $I_{T(RMS)}$       | RMS on-state Current (360° conduction angle)                                                      | $T_C = 75^\circ\text{C}$          | 60                         | A                                    |
| $I_{TSM}$          | Non Repetitive Surge Peak on-state Current ( $T_j$ initial = $25^\circ\text{C}$ - Half sine wave) | $t = 8.3 \text{ ms}$              | 550                        | A                                    |
|                    |                                                                                                   | $t = 10 \text{ ms}$               | 500                        |                                      |
| $I^2t$             | $I^2t$ Value for Fusing                                                                           | $t = 10 \text{ ms}$               | 1250                       | $\text{A}^2\text{s}$                 |
| $di/dt$            | Critical Rate of Rise of on-state Current (1)                                                     | Repetitive<br>$F = 50 \text{ Hz}$ | 50                         | $\text{A}/\mu\text{s}$               |
|                    |                                                                                                   | Non Repetitive                    | 300                        |                                      |
| $T_{sig}$<br>$T_j$ | Storage and Operating Junction Temperature Range                                                  |                                   | - 40 to 150<br>- 40 to 125 | $^\circ\text{C}$<br>$^\circ\text{C}$ |

| Symbol    | Parameter                             | TGAL |     |     |     |      | Unit |
|-----------|---------------------------------------|------|-----|-----|-----|------|------|
|           |                                       | 602  | 604 | 606 | 608 | 610  |      |
| $V_{DRM}$ | Repetitive Peak off-state Voltage (2) | 200  | 400 | 600 | 800 | 1000 | V    |

(1)  $I_G = 1.5 \text{ A}$   $di/dt = 1 \text{ A}/\mu\text{s}$   
 (2)  $T_j = 125^\circ\text{C}$ .

### THERMAL RESISTANCES

| Symbol                    | Parameter                                                           | Value | Unit                      |
|---------------------------|---------------------------------------------------------------------|-------|---------------------------|
| $R_{th (c-h)}$            | Contact (case-heatsink) for Recommended Stud Torque                 | 0.3   | $^\circ\text{C}/\text{W}$ |
| $R_{th (j-c)} \text{ DC}$ | Junction to Case for DC                                             | 0.66  | $^\circ\text{C}/\text{W}$ |
| $R_{th (j-c)} \text{ AC}$ | Junction to Case for 360 ° Conduction Angle ( $F = 50 \text{ Hz}$ ) | 0.5   | $^\circ\text{C}/\text{W}$ |

GATE CHARACTERISTICS (maximum values)

$P_{GM} = 40\text{ W}$  ( $t_p = 10\text{ }\mu\text{s}$ )       $I_{GM} = 6\text{ A}$  ( $t_p = 10\text{ }\mu\text{s}$ )  
 $P_{G(AV)} = 1\text{ V}$        $V_{GM} = 16\text{ V}$  ( $t_p = 10\text{ }\mu\text{s}$ )

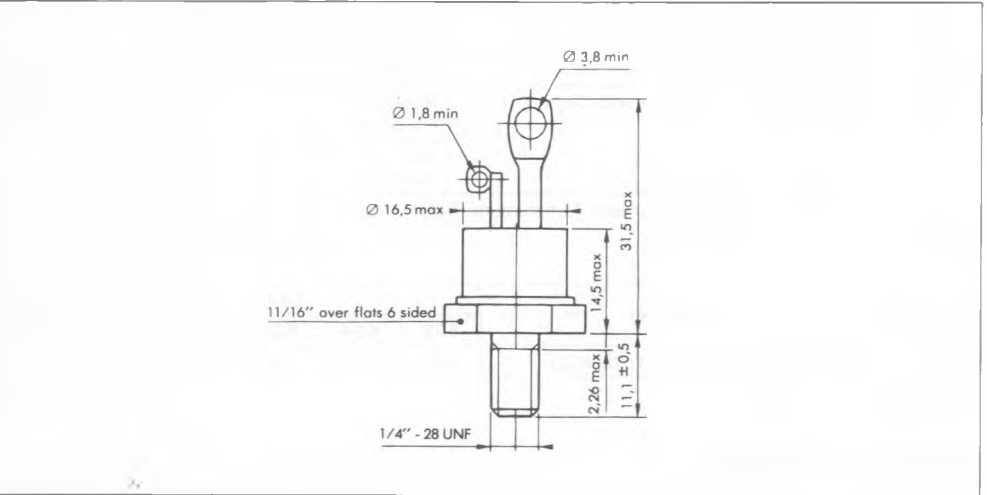
ELECTRICAL CHARACTERISTICS

| Symbol        | Test Conditions                                                                                                                     | Quadrants   | Min. | Typ. | Max. | Unit             |
|---------------|-------------------------------------------------------------------------------------------------------------------------------------|-------------|------|------|------|------------------|
| $I_{GT}$      | $T_J = 25\text{ }^\circ\text{C}$ $V_D = 12\text{ V}$ $R_L = 33\text{ }\Omega$<br>Pulse Duration $> 20\text{ }\mu\text{s}$           | I-III       |      |      | 100  | mA               |
|               |                                                                                                                                     | II-IV       |      |      | 150  |                  |
| $V_{GT}$      | $T_J = 25\text{ }^\circ\text{C}$ $V_D = 12\text{ V}$ $R_L = 33\text{ }\Omega$<br>Pulse Duration $> 20\text{ }\mu\text{s}$           | I-II-III-IV |      |      | 1.5  | V                |
| $V_{GD}$      | $T_J = 125\text{ }^\circ\text{C}$ $V_D = V_{DRM}$ $R_L = 3.3\text{ k}\Omega$                                                        | I-II-III-IV | 0.2  |      |      | V                |
| $I_H^*$       | $T_J = 25\text{ }^\circ\text{C}$ $I_T = 500\text{ mA}$ Gate Open                                                                    |             |      |      | 100  | mA               |
| $I_L$         | $T_J = 25\text{ }^\circ\text{C}$ $V_D = 12\text{ V}$ $I_G = 300\text{ mA}$<br>Pulse Duration $> 20\text{ }\mu\text{s}$              | I-III-IV    |      | 60   |      | mA               |
|               |                                                                                                                                     | II          |      | 120  |      |                  |
| $V_{TM}^*$    | $T_J = 25\text{ }^\circ\text{C}$ $I_{TM} = 100\text{ A}$ $t_p = 10\text{ ms}$                                                       |             |      |      | 2    | V                |
| $I_{DRM}^*$   | $T_J = 125\text{ }^\circ\text{C}$ $V_{DRM}$ Specified                                                                               |             |      |      | 10   | mA               |
| $dv/dt^*$     | $T_J = 125\text{ }^\circ\text{C}$ Gate Open<br>Linear Slope up to $V_D = 67\text{ }\% V_{DRM}$                                      |             | 250  |      |      | V/ $\mu\text{s}$ |
| $(dv/dt)_c^*$ | $T_C = 75\text{ }^\circ\text{C}$ $V_D = V_{DRM}$ $I_T = 100\text{ A}$<br>$(di/dt)_c = 26.7\text{ A/ms}$                             |             | 10   |      |      | V/ $\mu\text{s}$ |
| $t_{gi}$      | $T_J = 25\text{ }^\circ\text{C}$ $V_D = V_{DRM}$ $I_T = 100\text{ A}$<br>$I_G = 500\text{ mA}$ $di_G/dt = 3.5\text{ A}/\mu\text{s}$ | I-II-III-IV |      | 3    |      | $\mu\text{s}$    |

\* For either polarity of electrode  $A_2$  voltage with reference to electrode  $A_1$ .

PACKAGE MECHANICAL DATA

TO 65 Metal



Cooling method : by conduction (method C)  
Marking : type number  
Weight : 19 g without accessories  
Polarity : Electrode  $A_2$  to case  
Stud torque : 3.5 mAN min - 3.8 mAN max.

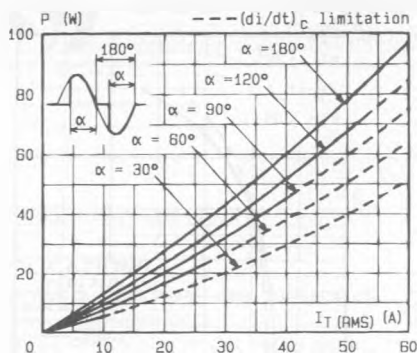


Fig.1 - Maximum mean power dissipation versus RMS on-state current ( $F = 60$  Hz).

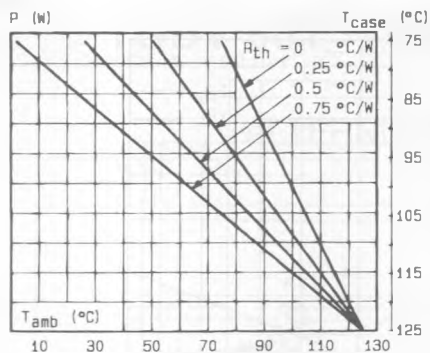


Fig.2 - Correlation between maximum mean power dissipation and maximum allowable temperatures ( $T_{amb}$  and  $T_{case}$ ) for different thermal resistances heatsink + contact.

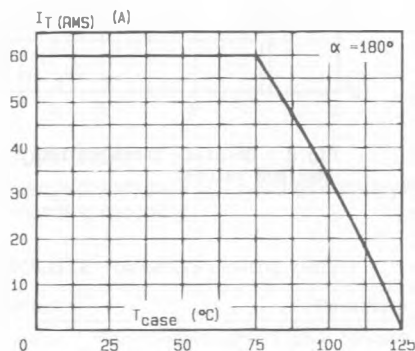


Fig.3 - RMS on-state current versus case temperature.

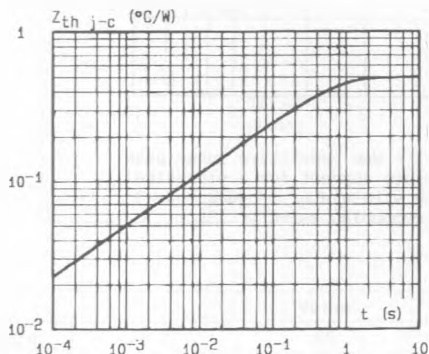


Fig.4 - Thermal transient impedance junction to case versus pulse duration.

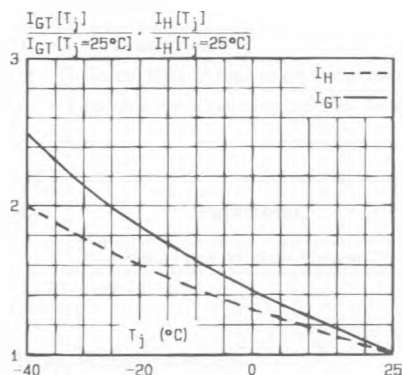


Fig.5 - Relative variation of gate trigger current and holding current versus junction temperature.

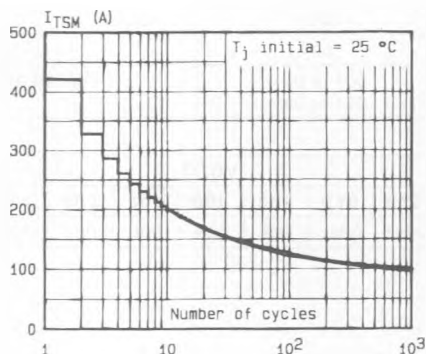


Fig.6 - Non repetitive surge peak on-state current versus number of cycles.

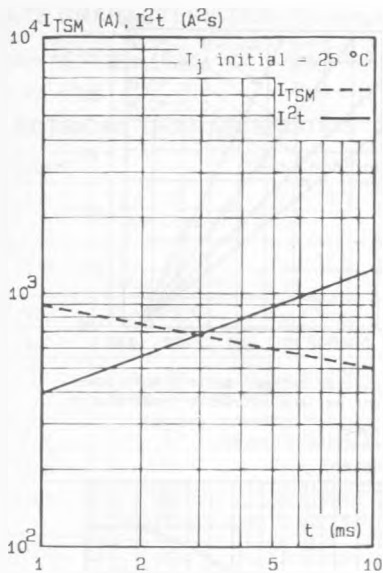


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width:  $t \leq 10$ ms, and corresponding value of  $I^2 t$ .

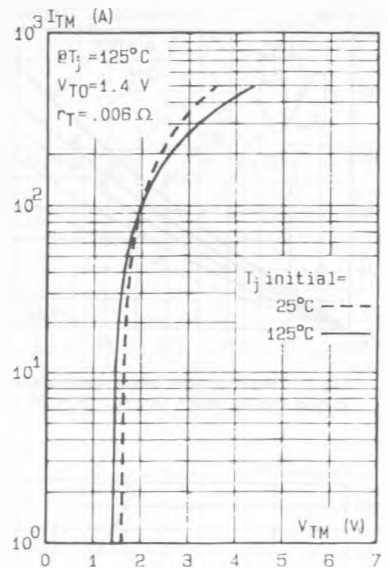


Fig.8 - On-state characteristic (maximum values).